



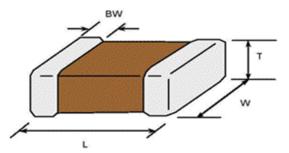
# **SPECIFICATION**

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL02A104KQ2NNNC
- Description : CAP, 100 nF, 6.3V, ±10%, X5R, 01005

A. Samsung Part Number

		<u>CL</u> 02 ① ②	<u>A</u> <u>104</u> 3 ④	<u>K</u> 5	<mark>Q</mark> 6	<mark>2</mark> ⑦	<u>N</u> ®	<u>N</u> 9	<u>N</u> 10	<u>C</u> 11	
1	Series	Samsung Multi-layer Ceramic Capacitor									
2	Size	01005 (inch code	) L:	0.40	± 0.02	2	mm		W:	0.20 ± 0.02	mm
3	Dielectric	X5R		8	Inner	eleo	ctrod	е		Ni	
4	Capacitance	<b>100</b> nF			Term	inat	ion			Cu	
5	Capacitance	±10 %			Platir	g				Sn 100%	(Pb Free)
	tolerance			9	Produ	ıct				Normal	
6	Rated Voltage	6.3 V		10	Spec	al				Reserved for	future use
1	Thickness	0.20 ± 0.02 mm	ı	1	Packa	agin	g			Cardboard Ty	/pe, 7" reel

## B. Structure and dimension



Samsung P/N	Dimension(mm)						
	L	L W		BW			
CL02A104KQ2NNNC	0.40±0.02	0.20±0.02	0.20±0.02	0.10±0.03			

#### C. Samsung Reliability Test and Judgement condition

	Performance	Test condition				
Capacitance	Within specified tolerance	1kl±±10% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at 150℃+0/-10℃ for 1 hour and maintained in				
Tan δ (DF)	0.125 max.	ambient air for 24±2 hours.				
Insulation	10,000Mohm or 10Mohm·µF	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance	No abnormal exterior appearance	Microscope (×20)				
Withstanding	No dielectric breakdown or	250% of the rated voltage				
Voltage	mechanical breakdown					
Temperature	X5R					
Characteristics	(From -55°C to 85°C, Capacitance changed	ge should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	100g·F, for 10±1 sec.				
of Termination	terminal electrode					
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
	is to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120 $^\circ C$ for 10~30sec.)				
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.				
Soldering heat	Tan δ, IR : initial spec.					
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm				
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)				
		2hours $\times$ 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance	Tan δ : 0.25 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	IR : 500Mohm or 0.5Mohm $\cdot \mu F$					
	Whichever is smaller					
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage				
Resistance	Tan δ : 0.25 max	Max. operating temperature				
	IR : 1,000Mohm or 0.5Mohm · μF					
	Whichever is smaller	1000+48/-0hrs				
Temperature	Capacitance change : within ±15%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow$ 25 °C				
		$\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C				
		5 cycle test				

\* The reliability test condition can be replaced by the corresponding accelerated test condition.

### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *5* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.